COILTRONICS[®]

High Current Power Inductors

FLAT-PAC[™] FP0708 Series



Description

- 125°C maximum total temperature operation
- 8.5 x 7.0 x 7.2mm surface mount package
- Ferrite core material
- High current carrying capacity
- Low core losses
- Controlled DCR tolerance for sensing circuits
- Inductance range from 72nH to 190nH
- Current range from 37 to 90Amps
- Frequency range up to 2MHz
- RoHS compliant

Applications

- Multi-phase regulators
- Voltage Regulator Module (VRM) •
- Point of load modules
- Servers and workstations
- Data networking and storage systems
- Notebook and desktop computers
- Graphics cards and battery power systems
- DCR sensing

Environmental Data

- Storage temperature range: -40°C to +125 °C
- Operating temperature range: -40°C to +125°C (Range is application specific)
- Solder reflow temperature: J-STD-020D complaint

Packaging

• Supplied in tape and reel packaging, 640 parts per reel, 13" dia. reel

Product Specifications							
Part Number	0CL1 ± 10% (nH)	FLL ² Min. (nH)	I _{rms} ³ (Amps)	I _{sat} 1⁴ @ 25°C (Amps)	I _{sat} 2 ⁵ @ 125°C (Amps)	DCR (mΩ) @ 20°C	K-factor ⁶
FP0708R1-R07-R	72	52		90	72		557
FP0708R1-R09-R	90	64	44	75	60		557
FP0708R1-R10-R	105	75		68	54	$0.35 \pm 8.6\%$	557
FP0708R1-R12-R	120	86	44	59	47	$0.30 \pm 0.0\%$	557
FP0708R1-R15-R	150	108		47	37		557
FP0708R1-R19-R	190	1.5		37	29		557

1 Open Circuit Inductance (OCL) Test Parameters: 100kHz, 0.10V_{rmS}, 0.0Adc

2 Full Load Inductance (FLL) Test Parameters: 100kHz, 0.1V_{rms}, I_{sat}1

3 Irms: DC current for an approximate temperature rise of 40°C without core loss. Derating is necessary for AC currents. PCB pad layout, trace thickness and width, air-flow and proximity of other heat generating components will affect the temperature rise. It is recommended the part temperature not exceed 125°C under worst case operating conditions verified in the end application.

- 4 Isat1: Peak current for approximately 20% rolloff at +25°C.
- 5 Isat2: Peak current for approximately 20% rolloff at +125°C.
- 6 K-factor: Used to determine B_{p-p} for core loss (see graph). $B_{p-p} = K * L * \Delta I * 10^{-3}$, B_{p-p} : (Gauss), K: (K-factor from table), L: (inductance in nH), ΔI (peak-to-peak ripple current in amps).
- 7 Part Number Definition: FP0705Rx-Rxx-R
 - FP0708 = Product code and size • Rxx= Inductance value in μ H, R = decimal point • "-R" suffix = RoHS compliant
 - Rx is the DCR indicator

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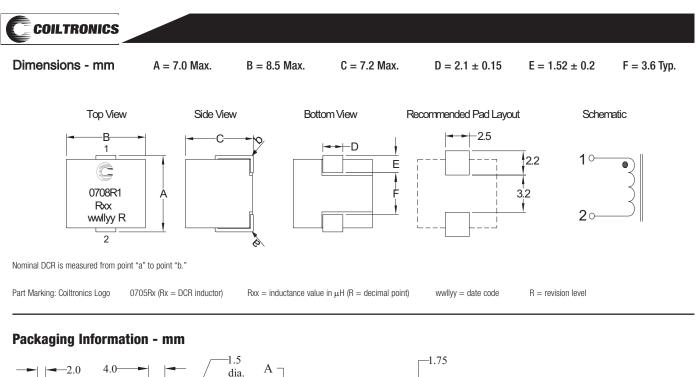
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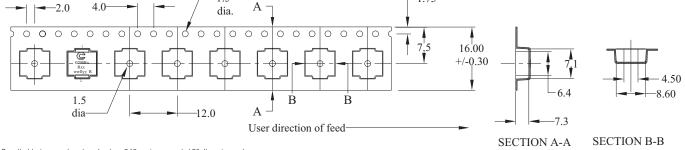




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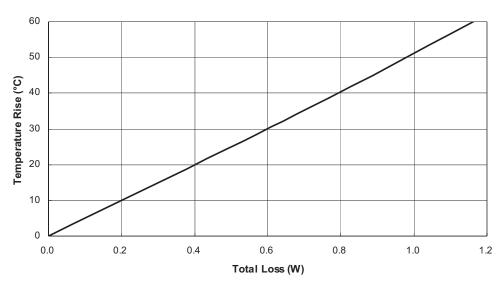






Supplied in tape-and-reel packaging, 640 parts per reel, 13" diameter reel.

Temperature Rise vs.Total Loss

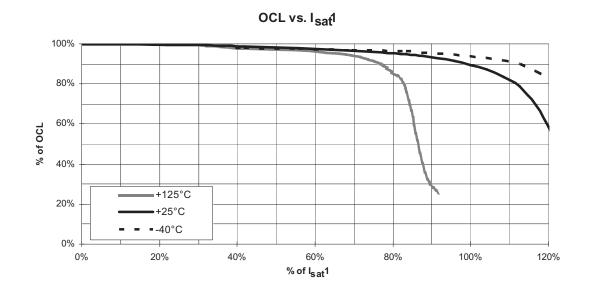




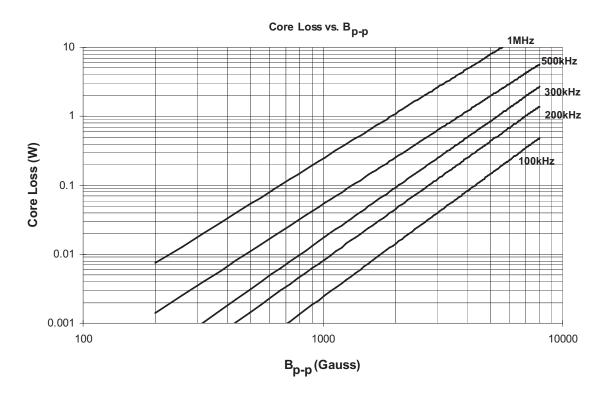
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Inductance Characteristics



Core Loss





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Solder Reflow Profile

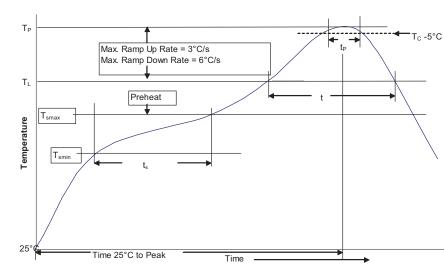


Table 1 - Standard SnPb Solder (T _C)					
Package	Volume mm ³	Volume mm ³			
Thickness	<350	≥350			
<2.5mm	235°C	220°C			
≥2.5mm	220°C	220°C			

Table 2 - Lead (Pb) Free Solder (T_c)

Package Thickness	Volume mm³ <350	Volume mm ³ 350 - 2000	Volume mm ³ >2000
<1.6mm	260°C	260°C	260°C
1.6 – 2.5mm	260°C	250°C	245°C
>2.5mm	250°C	245°C	245°C

Reference JDEC J-STD-020D

Profile Feature		Standard SnPb Solder	Lead (Pb) Free Solder	
Preheat and Soak	 Temperature min. (T_{smin}) 	100°C	150°C	
	 Temperature max. (T_{smax}) 	150°C	200°C	
	 Time (T_{smin} to T_{smax}) (t_s) 	60-120 Seconds	60-120 Seconds	
Average ramp up rate T _{smax} to T _p		3°C/ Second Max.	3°C/ Second Max.	
Liquidous temperature (TL)		183°C	217°C	
Time at liquidous (t _L)		60-150 Seconds	60-150 Seconds	
Peak package body temperature (T _P)*		Table 1	Table 2	
Time $(t_p)^{**}$ within 5 °C of the specified classification temperature (T_c)		20 Seconds**	30 Seconds**	
Average ramp-down rate (Tp to T _{smax})		6°C/ Second Max.	6°C/ Second Max.	
Time 25°C to Peak Temperature		6 Minutes Max.	8 Minutes Max.	

 * Tolerance for peak profile temperature (T_p) is defined as a supplier minimum and a user maximum.

** Tolerance for time at peak profile temperature (t_p) is defined as a supplier minimum and a user maximum.

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